

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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**Preferred Device** 

## **Sidac High Voltage**

### **Bidirectional Triggers**

Bidirectional devices designed for direct interface with the ac power line. Upon reaching the breakover voltage in each direction, the device switches from a blocking state to a low voltage on–state. Conduction will continue like a Triac until the main terminal current drops below the holding current. The plastic axial lead package provides high pulse current capability at low cost. Glass passivation insures reliable operation.

#### **Features**

- High Pressure Sodium Vapor Lighting
- Strobes and Flashers
- Ignitors
- High Voltage Regulators
- Pulse Generators
- Used to Trigger Gates of SCR's and Triacs
- N Indicates UL Registered File #E116110
- Pb-Free Package is Available

### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Rating  | Symbol                     | Value       | Unit |
|---|----------------------------|-------------|------|
| Peak Repetitive Off–State Voltage (Sine Wave, 50 to 60 Hz, T <sub>J</sub> = -40 to 125°C)     | $V_{ m DRM}, \ V_{ m RRM}$ | ±90         | V    |
| On-State Current RMS<br>(T <sub>L</sub> = 80°C, Lead Length = 3/8""<br>All Conduction Angles) | I <sub>T(RMS)</sub>        | ± 0.9       | Α    |
| Peak Non-repetitive Surge Current (60 Hz One Cycle Sine Wave, T <sub>J</sub> = 125°C)         | I <sub>TSM</sub>           | ± 4.0       | Α    |
| Operating Junction Temperature Range  | $T_J$                      | -40 to +125 | °C   |
| Storage Temperature Range   | T <sub>stg</sub>           | -40 to +150 | °C   |

### THERMAL CHARACTERISTICS

| Rating  | Symbol         | Max | Unit |
|---|----------------|-----|------|
| Thermal Resistance, Junction-to-Lead<br>Lead Length = 3/8"        | $R_{	heta JL}$ | 40  | °C/W |
| Lead Solder Temperature (Lead Length ≥ 1/16" from Case, 10 s Max) | T <sub>L</sub> | 260 | °C   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



### ON Semiconductor®

http://onsemi.com

### SIDACS (%) 0.9 AMPS RMS, 160 VOLTS





### MARKING DIAGRAM



A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

| Device      | Package     | Shipping <sup>†</sup> |
|-------------|-------------|-----------------------|
| MKP9V160RL  | Axial Lead* | 5000 Tape & Reel      |
| MKP9V160RLG | Axial Lead* | 5000 Tape & Reel      |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

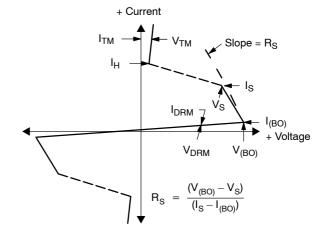
<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

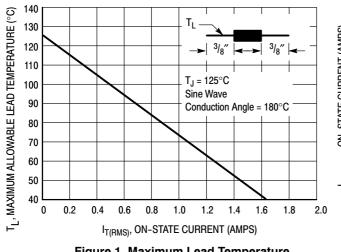
### $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_C = 25^{\circ}\text{C unless otherwise noted}; \ \text{Electricals apply in both directions})$

| Character  | Symbol   | Min              | Тур | Max | Unit |      |
|--|--|------------------|-----|-----|------|------|
| OFF CHARACTERISTICS  |  |                  |     |     |      |      |
| Repetitive Peak Off-State Current<br>(50 to 60 Hz Sine Wave)   | T <sub>J</sub> = 25°C<br>V <sub>DRM</sub> = 90 V | I <sub>DRM</sub> | -   | _   | 5.0  | μΑ   |
| ON CHARACTERISTICS   |  |                  |     |     |      |      |
| Breakover Voltage<br>I <sub>BO</sub> = 200 μA  |  | V <sub>BO</sub>  | 150 | _   | 170  | V    |
| Peak On–State Voltage<br>(I <sub>TM</sub> = 1 A Peak, Pulse Width ≤ 300 μs,  | Duty Cycle ≤ 2%)                                 | V <sub>TM</sub>  | -   | 1.3 | 1.5  | V    |
| Dynamic Holding Current (Sine Wave, 50 to 60 Hz, R <sub>L</sub> = 100 Ω)   |  | IH               | -   | _   | 100  | mA   |
| Switching Resistance<br>(Sine Wave, 50 to 60 Hz)   |  | R <sub>S</sub>   | 0.1 | _   | _    | kΩ   |
| DYNAMIC CHARACTERISTICS  |  | ·                | •   | •   | •    |      |
| Critical Rate-of-Rise of On-State Current, Critical Damped Waveform Circuit (I <sub>PK</sub> = 130 A, Pulse Width = 10 μsec) |  | di/dt            | _   | 120 | _    | A/μs |

# Voltage Current Characteristic of SIDAC (Bidirectional Device)

| Symbol           | Parameter                             |
|------------------|---------------------------------------|
| I <sub>DRM</sub> | Off State Leakage Current             |
| $V_{DRM}$        | Off State Repetitive Blocking Voltage |
| V <sub>BO</sub>  | Breakover Voltage                     |
| I <sub>BO</sub>  | Breakover Current                     |
| I <sub>H</sub>   | Holding Current                       |
| $V_{TM}$         | On State Voltage                      |
| I <sub>TM</sub>  | Peak on State Current                 |





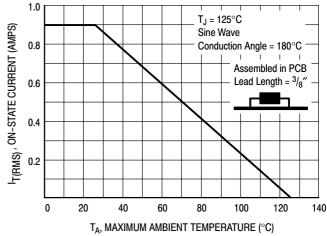
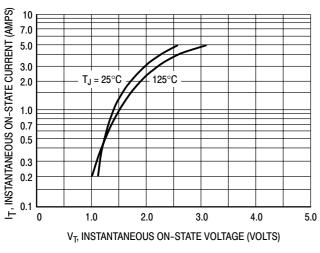


Figure 1. Maximum Lead Temperature

Figure 2. Maximum Ambient Temperature



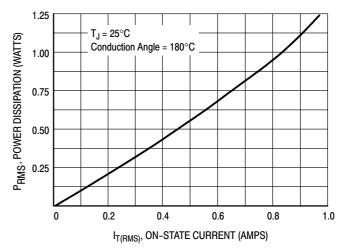


Figure 3. Typical On-State Voltage

Figure 4. Typical Power Dissipation

### THERMAL CHARACTERISTICS

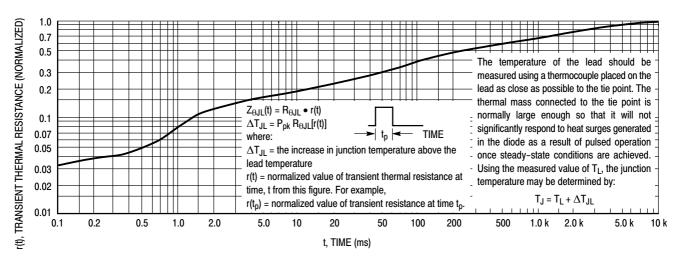


Figure 5. Thermal Response

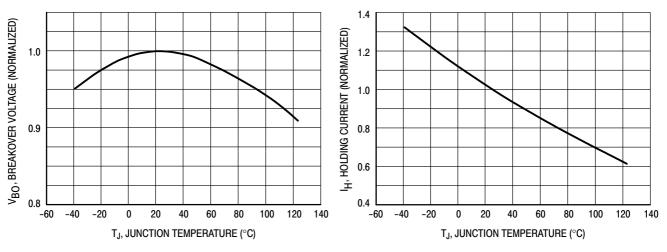


Figure 6. Typical Breakover Voltage

Figure 7. Typical Holding Current

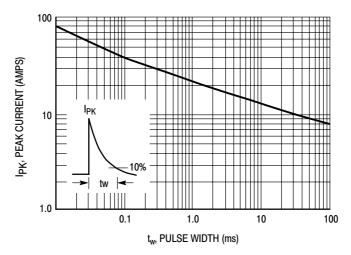
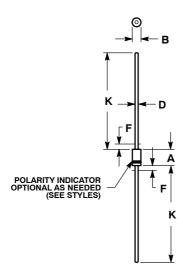


Figure 8. Pulse Rating Curve

#### PACKAGE DIMENSIONS

AXIAL LEAD CASE 59-10 ISSUE U



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   MARKATANA 1000
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY
- 4. POLARITY DENOTED BY CATHODE BAND.
- LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

|     | INCHES |       | MILLIM | ETERS |
|-----|--------|-------|--------|-------|
| DIM | MIN    | MAX   | MIN    | MAX   |
| Α   | 0.161  | 0.205 | 4.10   | 5.20  |
| В   | 0.079  | 0.106 | 2.00   | 2.70  |
| D   | 0.028  | 0.034 | 0.71   | 0.86  |
| F   |        | 0.050 |        | 1.27  |
| к   | 1 000  |       | 25 40  |       |

STYLE 2:

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